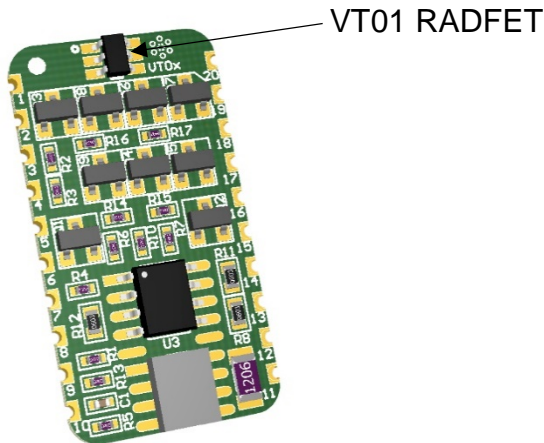


TECHNICAL DATA

RM-VT01-A

VT01 RADFET Readout Module



Description

The RM-VT01-A RADFET Read-out Module is a result of many years of experience of Varadis engineers in designing RADFET read-out circuitry. Aimed at providing an optimized RADFET read-out and cutting customers' development time and cost, the RM-VT01-A contains the VT01 RADFET and key circuitry for its readout. The module outputs a buffered analog voltage (RADFET threshold voltage), which is related to accumulated radiation dose of the RADFET. Due to its small size, RM-VT01-A can easily be integrated into customer's system by soldering directly onto the PCB or via a standard through-hole header connector.

RM-VT01-A is specially designed for and optimized around Varadis VT01 RADFET, with current source individually adjusted for each part to minimize RADFET threshold voltage drift due to temperature.

The threshold voltage of the RADFET is buffered for easier integration with standard analog to digital converters, significantly simplifying customer's electronics design.

Both Read-out and Irradiation (sense) modes of RADFET operation are supported. The user can easily select the desired mode by TTL logic level control signals.

Features

- Facilitates optimum RADFET read-out and saves on our customer's development time and costs.
- Contains VT01 RADFET and critical read-out circuitry.
- Supports Read-out and Irradiation modes of RADFET operation.
- Main features:
 - Individually adjusted current source to minimize temperature influence
 - Buffered analog output voltage
 - TTL Logic control
 - Single supply
 - Zero power operation
 - Low power readout
- Easy integration with customer's system as a surface mounted component or through-hole standard header pin connector
- Dose range from 1 cGy to 1 kGy (1 Rad to 100 kRad)

Typical applications

- General purpose radiation detection
- Satellites
- Medical equipment
- Accelerator facilities
- Nuclear power stations

Connector Assignment and Dimensions

RM-VT01-A connector assignment and PCB outline drawing are given in Figure 1, and pin description in Table 1.

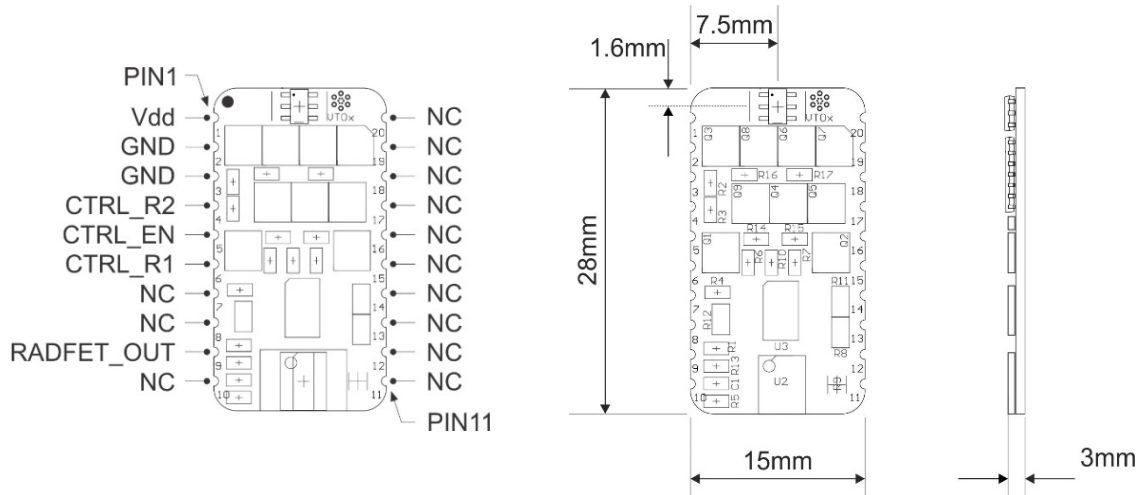


Figure 1: RM-VT01-A connector assignment and PCB outline drawing and dimensions.

Table 1: Pin description.

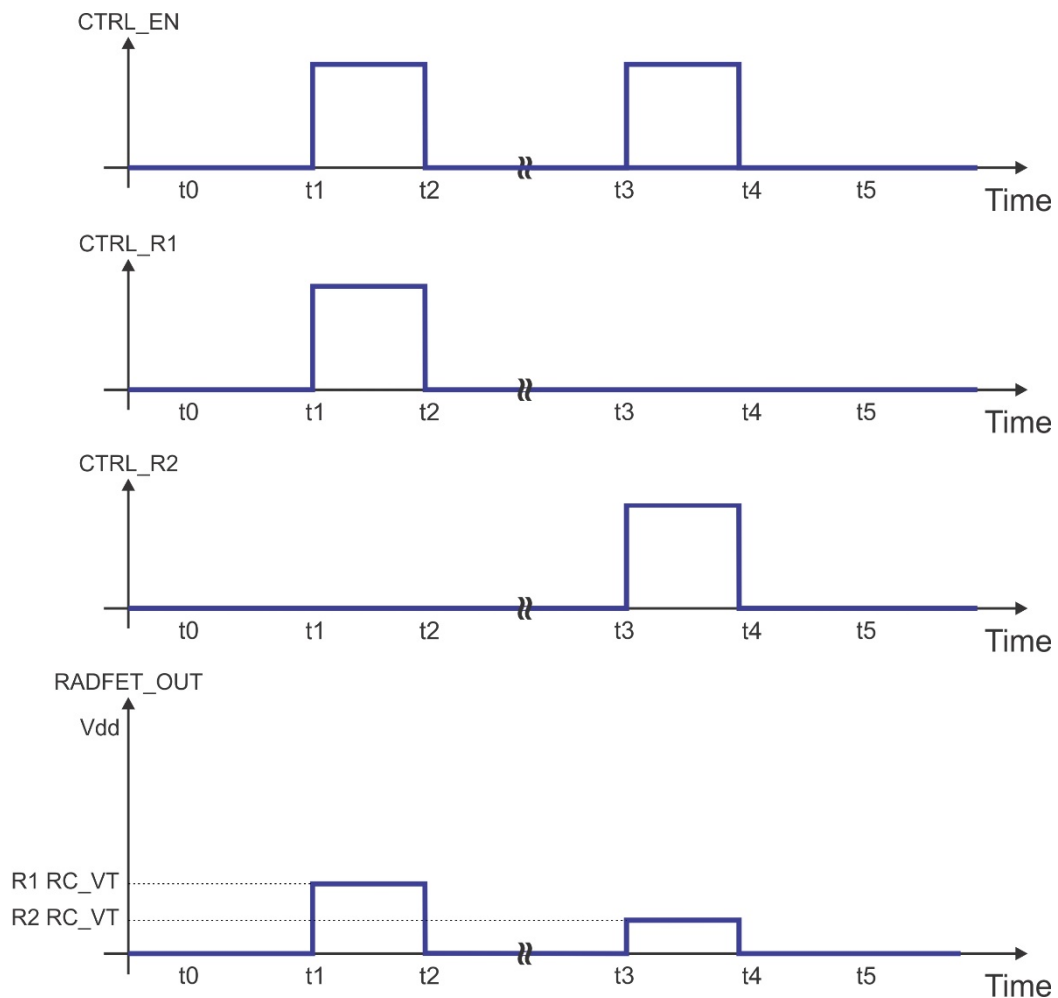
Pin No.	Pin name	Pin type	Description / Recommendations
1	Vdd	POWER	Positive power supply, this pin must be decoupled with 10 μ F ceramic, low ESR capacitor.
2	GND	GND	Connect to power supply ground.
3	GND	GND	Connect to power supply ground.
4	CTRL_R2	Digital IN	RADFET R2 selection signal.
5	CTRL_EN	Digital IN	Enable signal.
6	CTRL_R1	Digital IN	RADFET R1 selection signal.
7	NC	-	Not connected; this pin should be left floating or connected to GND.
8	NC	-	Not connected; this pin should be left floating.
9	RADFET_OUT	Analog OUT	VT01 RADFET output voltage, selectable via control signals.
10-20	NC	-	Not connected; these pins can be left floating or connected to GND.

Table 3: Read-out truth table.

CTRL_EN	CTRL_R2	CTRL_R1	RADFET_OUT	Description
0	0 1	0 1	0 V	RADFETs in irradiation mode (All terminals grounded).
1	0	1	$V_{TH} (R1)$	R1 in Read-out mode, R2 in Irradiation mode.
1	1	0	$V_{TH} (R2)$	R1 in Irradiation mode, R2 in Read-out mode.
1	1	1	Undefined Output stage	Do not use.

RADFET Output Voltage Values and Timing

An example of typical voltage output values and enable sequence shown in Figure 3 and 4.


Figure 3: RM-VT01-A Output Voltage Values and Timing example1.

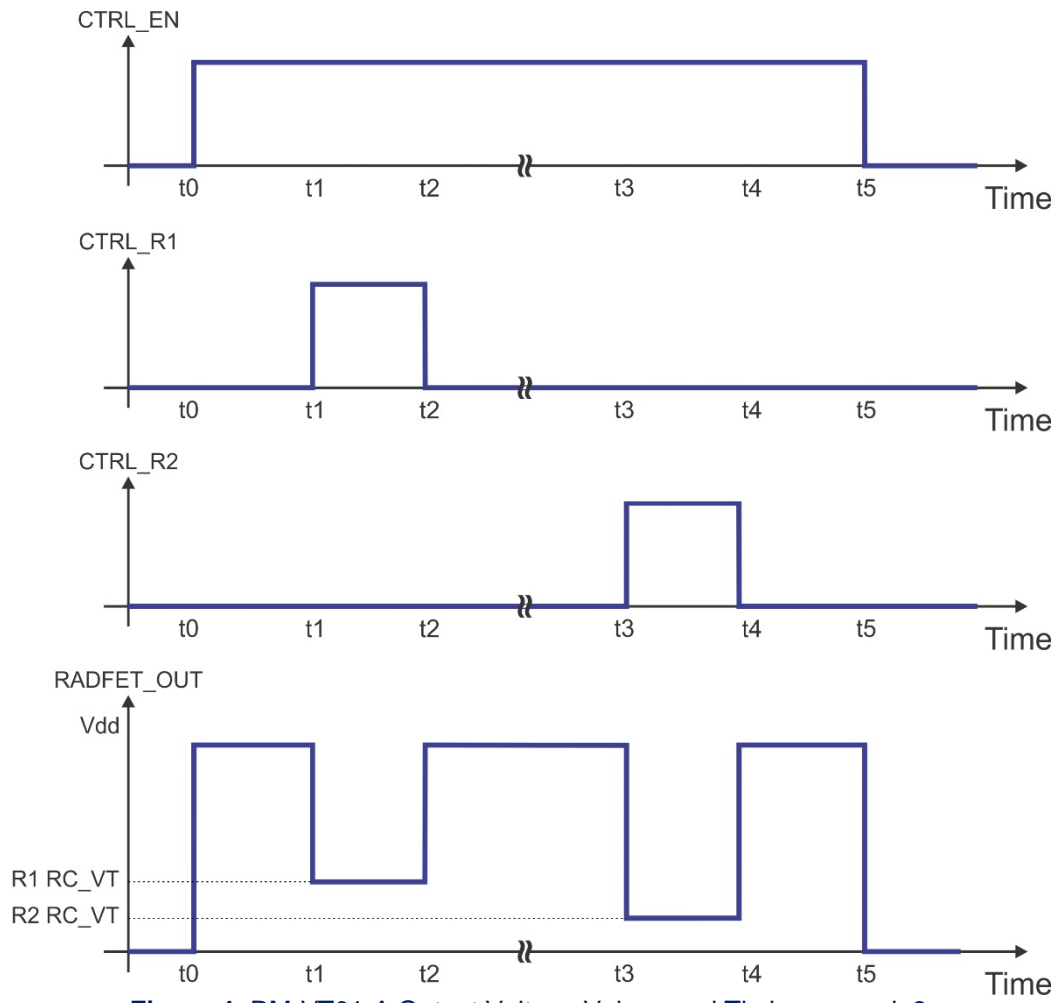


Figure 4: RM-VT01-A Output Voltage Values and Timing example2.

Radiation Calibration Data

The calibration curve for the RM-VT01-A shows evolution of ΔV (**RADFET_OUT pin voltage change with reference to its pre-irradiation value**) with dose. Note that a specific calibration curve, obtained using the Co-60 source, is associated with each RADFET production batch. The calibration curve, together with analytical equation and fitting coefficients, will be provided with the supplied parts. For illustration, a typical calibration curve is shown in Figure 5.

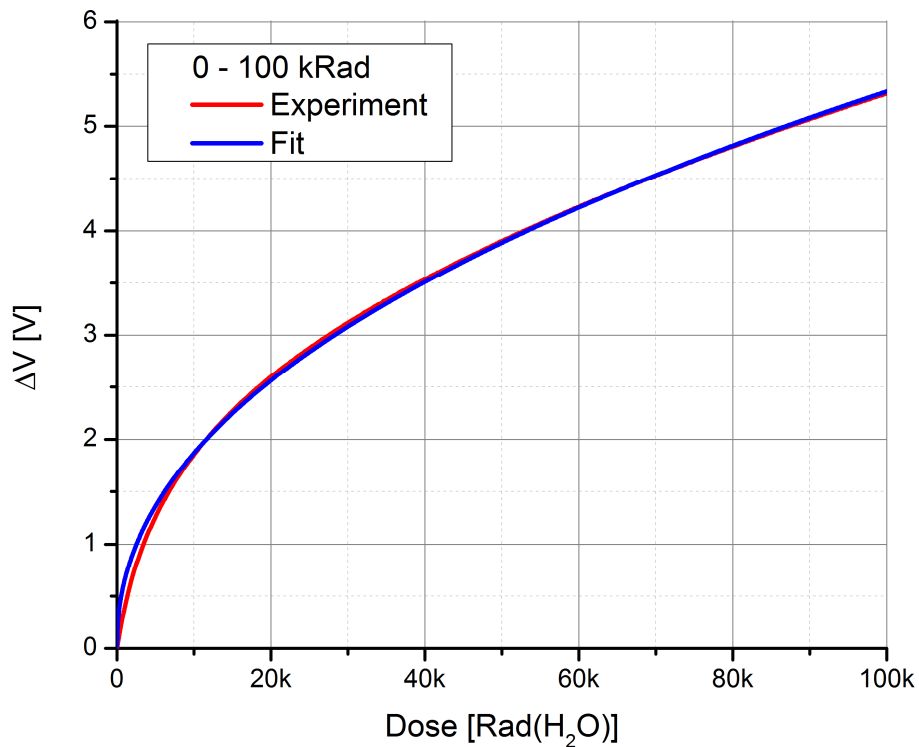


Figure 5: Typical calibration curve indicating change in voltage during irradiation. Irradiation at room temperature with Co-60 gamma source, dose rate ~50 Gy/h (5 krad/h). Voltage measurements were performed at room temperature.

Recommended Operating Conditions

RM-VT01-A module recommended operating conditions are given in Table 4.

Table 4: Recommended operating conditions.

Symbol	Parameter	Value	Unit
V _{DD}	Supply voltage, referenced to GND	12	V
CTRL_EN	Enable signal	5 or 3.3	V
CTRL_R1	RADFET R1 selection signal	5 or 3.3	V
CTRL_R2	RADFET R2 selection signal	5 or 3.3	V
T	Ambient operating temperature	22 ±10	°C
ARH	Ambient relative humidity (non-condensing)	< 85	%

DC Electrical Characteristics

RM-VT01-A module DC electrical characteristics are given in Table 5.

Table 5: DC electrical characteristics.

Symbol	Parameter	Conditions	Limits			Unit
			Min	Typ	Max	
V _{DD}	Supply voltage, referenced to GND	T=22°C	-	12	24	V
I _{DD}	Supply current	CTRL_EN = 1	-	2	-	mA
		CTRL_EN = 0	-	-	0.1	µA
V _{RADFET_OUT}	Module output voltage ¹	I _L = 0.1mA	0.8	1.8	V _{DD}	V
I _L	Output load current		0	0.1	1	mA
V _{CTRL_R1} V _{CTRL_R2}	Control signal voltage		3	5	V _{DD} -1	V
V _{CTRL_EN}	Module enable voltage		3	5	V _{DD} -1	V
T _{ON}	CTRL_R1, CTRL_R2 on time		0.025	0.25	1 ²	s
T _{OFF}	CTRL_R1, CTRL_R2 off time		15	-	-	s

¹ The RADFET threshold voltage is dependent on accumulated radiation dose, please see VT01 datasheet for more details. The RADFET threshold voltage is available at pin 9 (RADFET_OUT).

² If more than 1s CTRL_ON time is required, please contact Varadis

Recommended Circuit Interface

An example of a circuit interface is shown in Figure 6.

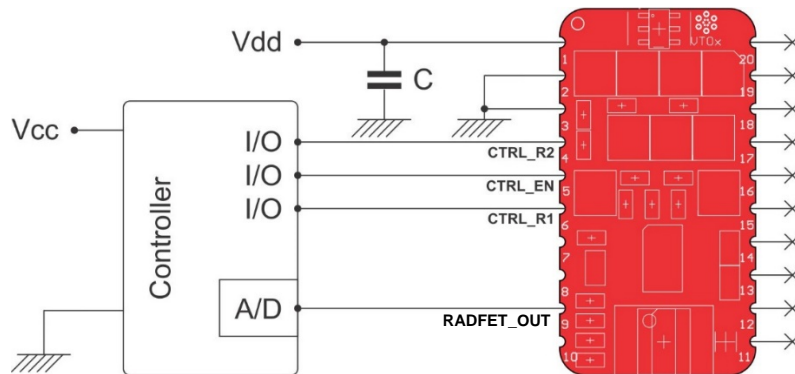


Figure 6: RM-VT01-A interface with microcontroller.

Soldering and Mounting

It is important that the RM-VT01-A is the last component to be hand soldered onto a circuit board. If a different soldering profile is required, please contact us at support@varadis.com. RM-VT01-A can be soldered directly on the customer PCB treated as SMD. Recommended dimensions for solder pad layout are given in Figure 7.

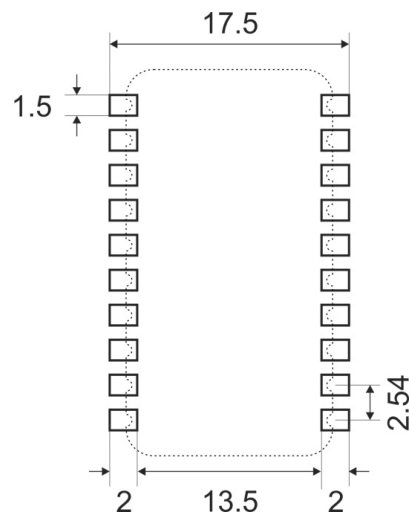


Figure 7: Recommended solder pad layout. All dimensions are in millimeters. Note the drawing is not to scale.

Handling

All assembled boards undergo 100% electrical test and visual inspection immediately prior to shipment. Therefore, all boards should reach the customer in excellent condition. To ensure that the boards remain in this condition, please handle the parts as carefully as possible and observe standard precautions related to ESD sensitive devices.

Notes

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